AN-1330 LM5008 Evaluation Board

1 Introduction

The LM5008 evaluation board is designed to provide the design engineer with a fully functional step down switching regulator to evaluate LM5008 regulator IC, in a typical environment.

The performance of evaluation board is as follows:

- Input range: 12V to 95V, transients upto 100V **(absolute maximum)**
- Output voltage: 10V
- Output current: 300mA
- Measured efficiency: 89% at 200mA and $V_{IN} = 30V$
- Board size: 31.9mm x 44.4mm

2 Theory of Operation

The LM5008 step-down switching regulator features all of the functions needed to implement low cost, efficient, Buck bias regulators. This high voltage regulator contains an 100V, 0.5A N-channel Buck switch. The regulator is based on hysteretic control scheme using an on-time inversely proportional to input voltage (V_{IN}). This feature allows the operating frequency to remain relatively constant with load and input voltage variations. The hysteretic control requires no control loop compensation, while providing fast load transient response. Additional protection features include : Thermal Shutdown, V_{CC} undervoltage lockout and maximum duty–cycle limiter. LM5008 can be used in numerous applications to efficiently regulate step down higher voltage inputs. This regulator is well suited for 48V telecom and the new 42V automotive power bus ranges.

The LM5008 operates in discontinuous conduction mode at light load currents or continuous conduction mode at heavier load currents. In discontinuous conduction mode, current through the output inductor starts at zero and ramps up to the peak value during the buck switch on time, and then back to zero during buck switch off time. In discontinuous conduction mode, the operating frequency can be relatively low and will vary with load. Therefore at light loads the conversion efficiency is maintained , since switching losses decrease with reduction in switching frequency.

The evaluation board just needs one high voltage power-supply (upto 100V and current rating of 0.5A). The maximum output power is 3 watts. Either an electronic load or resistor bank can be used for testing evaluation board.

3 Start-up Feature

There is no soft-start feature in LM5008, and it normally comes up with full load current to supply the power demanded by the load within a short time. The LM5008 contains an intelligent current limit OFF timer intended to reduce the foldback characteristic inherent with fixed off-time over-current protection. If the current in the Buck FET exceeds 550mA the present cycle is immediately terminated (cycle by cycle current limit). Following the termination of the cycle a non-resetable current limit off timer is initiated. The duration of off time is a function of the external setting resistor (Rcl) and the FB pin voltage. When FB pin voltage = 0V the current limit off time is internally preset to 35µs. This condition occurs in short circuit operation when a maximum amount of off time is required.

In cases of overload (not complete short circuit) the current limit off time can be reduced as a function of the output voltage (measured at the FB pin). Reducing the off time during smaller overloads reduces the amount of foldback and also reduces the initial start-up time.

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4   Low Ripple Configuration

For applications where lower output voltage ripple is required the output load can be connected directly to the low ESR output capacitor, as shown below. The evaluation board is laid out in such a way that, user can use either (high ripple or low ripple) options by simply shifting the output connector. The series resistor (R) will degrade the load regulation however.
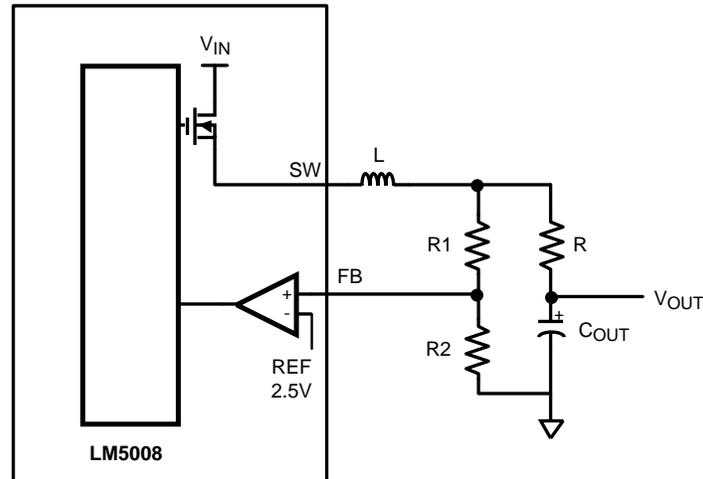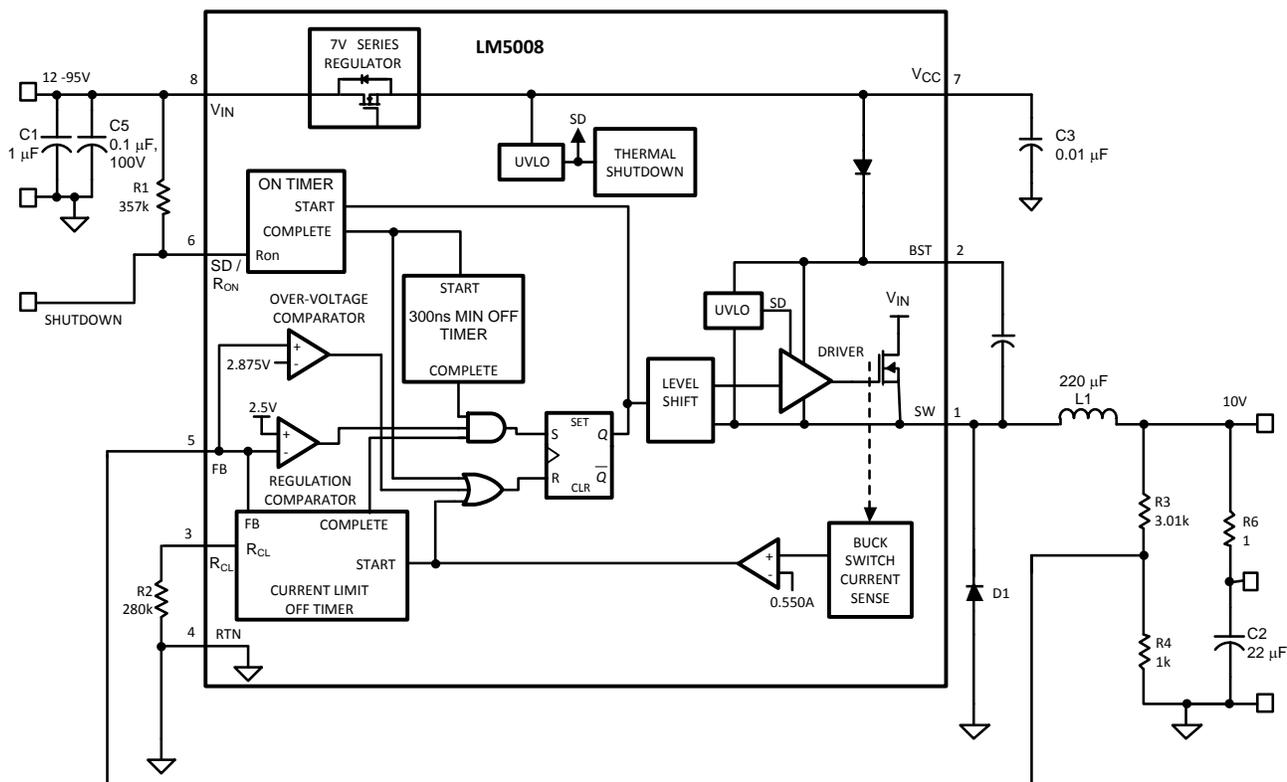

Figure 1. Low Ripple Configuration Output

Figure 2. Evaluation Board Schematic Diagram

Table 1. Bill of Materials

ITEM		PART NUMBER	DESCRIPTION	VALUE
C	1	C4532X7R2A105M	CAPACITOR, CER, TDK	1µ, 100V
C	2	C3225X7R1C226M	CAPACITOR, CER, TDK	22µ, 16V
C	3	C1206C104K5RAC	CAPACITOR, CER, KEMET	0.1µ, 50V
C	4	C1206C103K5RAC	CAPACITOR, CER, KEMET	0.01µ, 50V
C	5	C3216X7R2A104KT	CAPACITOR, CER, TDK	0.1µ, 100V
D	1	MURA110T3	DIODE, 100V, ON SEMI	
L	1	SLF10145T-221MR65-1	BUCK INDUCTOR, TDK	220µH
R	1	CRCW12063573F	RESISTOR	357K
R	2	CRCW12062803F	RESISTOR	280K
R	3	CRCW12063011F	RESISTOR	3.01K
R	4	CRCW12061001F	RESISTOR	1K
R	5	CRCW12061R00F	RESISTOR	1
U	1	LM5008	REGULATOR, NATIONAL	

5 Efficiency Measurements
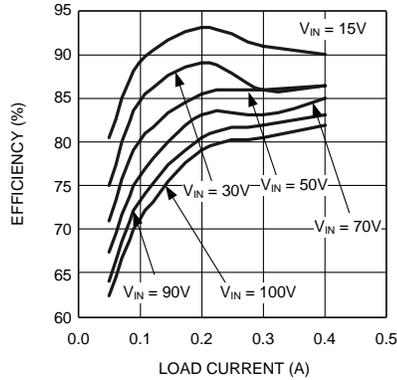
Figure 3. LM5008 Efficiency
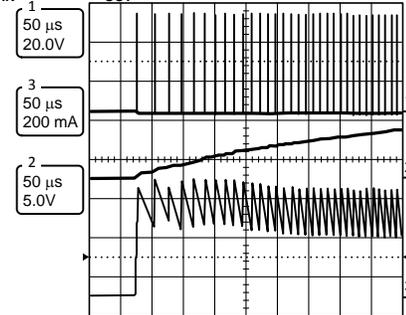
CH1: Switch Node Voltage
CH2: Output Voltage
CH3: Inductor Current

Figure .
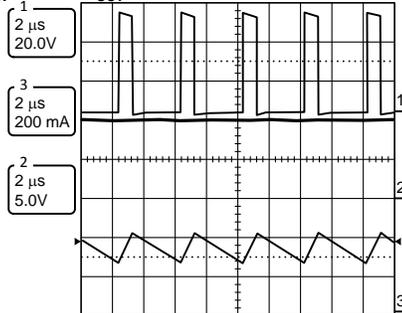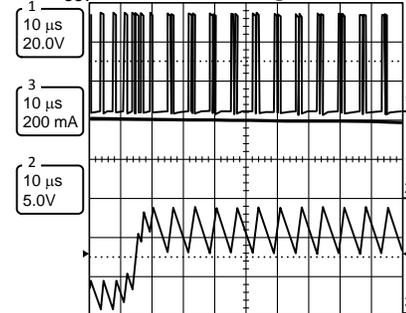
CH1: Switch Node Voltage
CH2: Output Voltage
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CH1: Switch Node Voltage
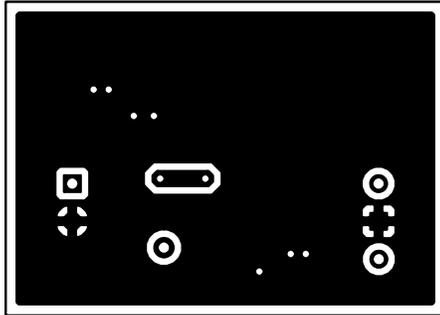CH2: Output Voltage
CH3: Inductor Current
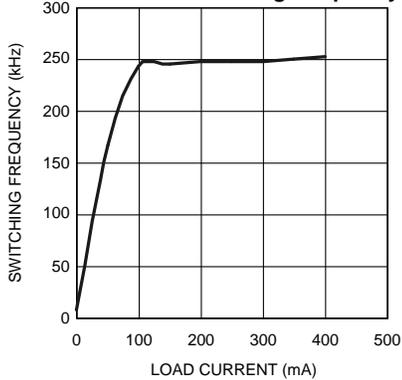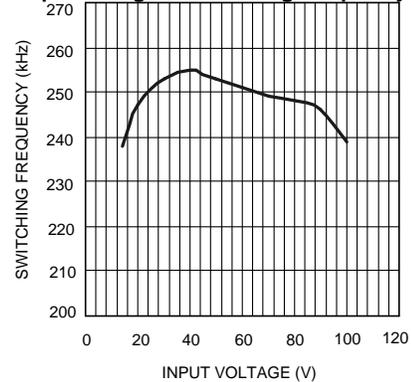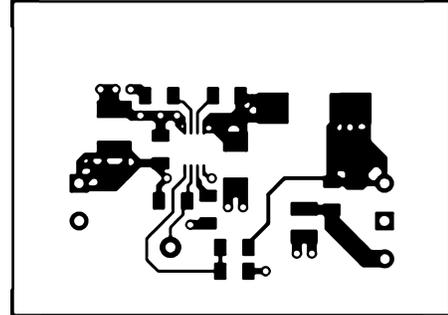
6 PCB Layouts
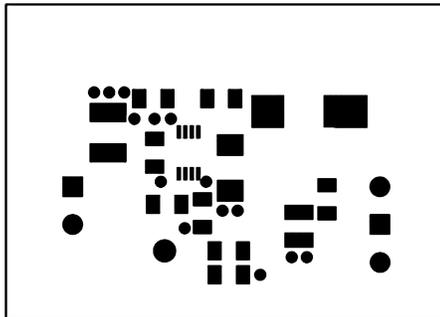

Figure 4. Top Layer
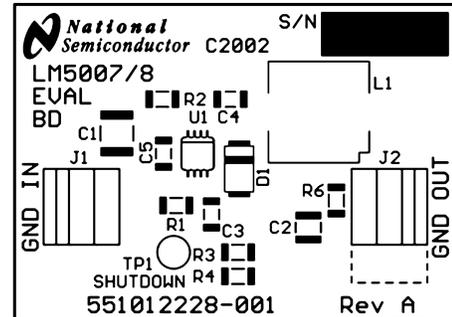

Figure 5. Silk Screen

Figure 6. Bottom Layer

Figure 7. Top Soldermask

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